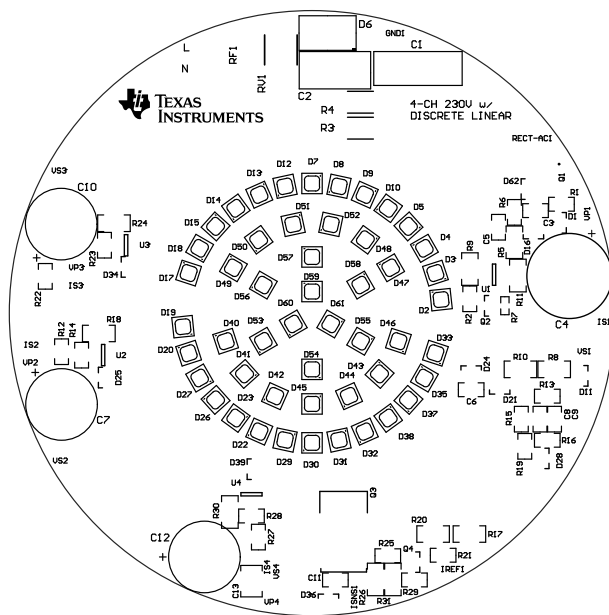
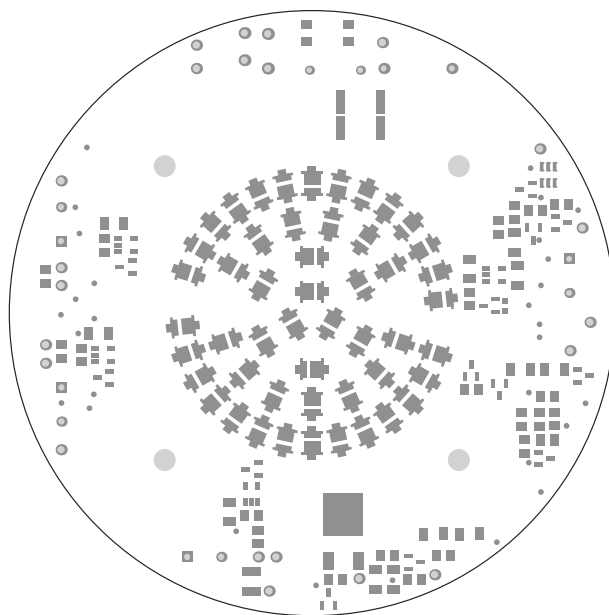
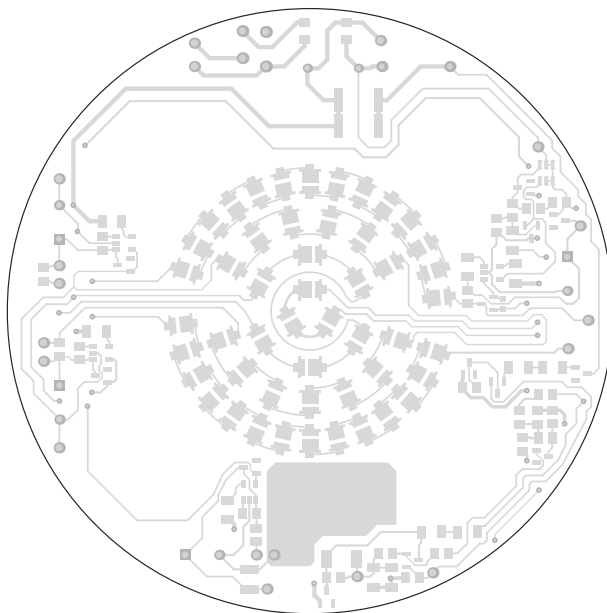




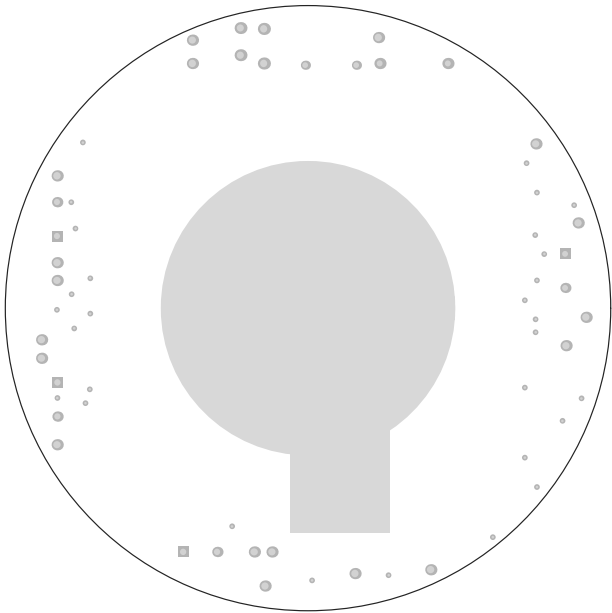
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP6020	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay			
PLOT NAME = Top Overlay	GENERATED : 12/16/2014 8:21:37 AM	TEXAS INSTRUMENTS	



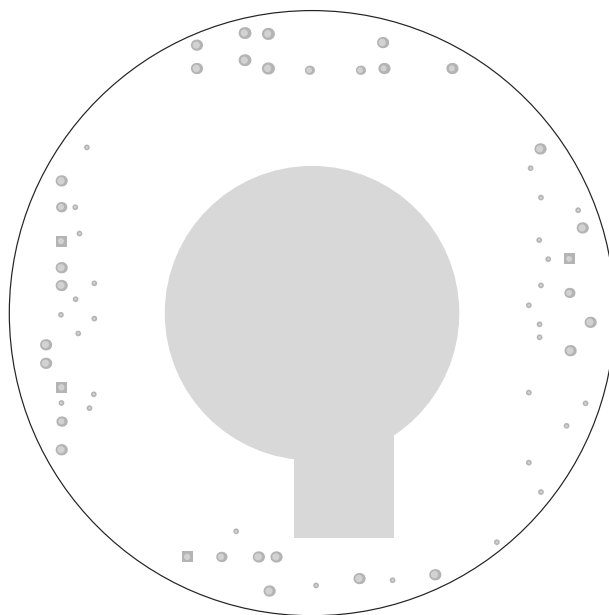
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP6020	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = Top Solder			
PLOT NAME = Top Solder Mask	GENERATED : 12/16/2014 8:21:40 AM	TEXAS INSTRUMENTS	



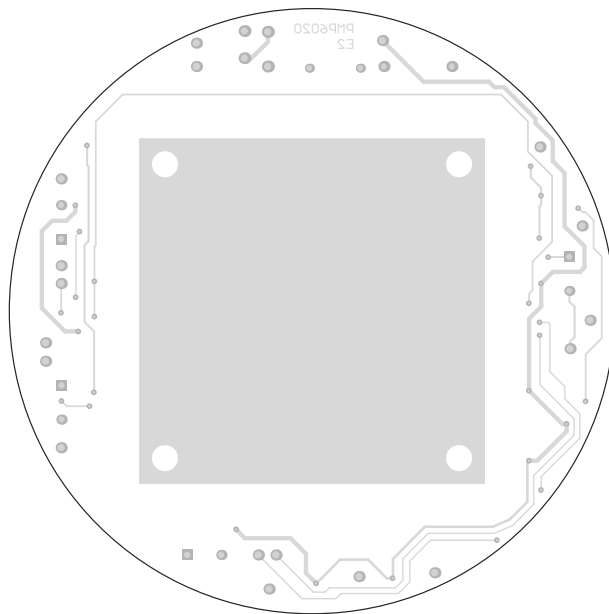
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP6020	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = Top Layer			
PLOT NAME = Top Layer	GENERATED : 12/16/2014 8:21:41 AM	TEXAS INSTRUMENTS	



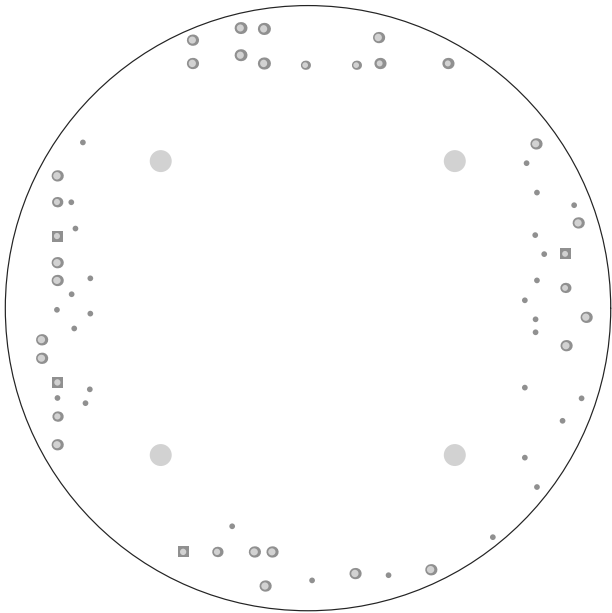
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP6020	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = MidLayer1			
PLOT NAME = MidLayer1	GENERATED : 12/16/2014 8:21:43 AM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP6020	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = MidLayer2			
PLOT NAME = MidLayer2	GENERATED : 12/16/2014 8:21:45 AM	TEXAS INSTRUMENTS	

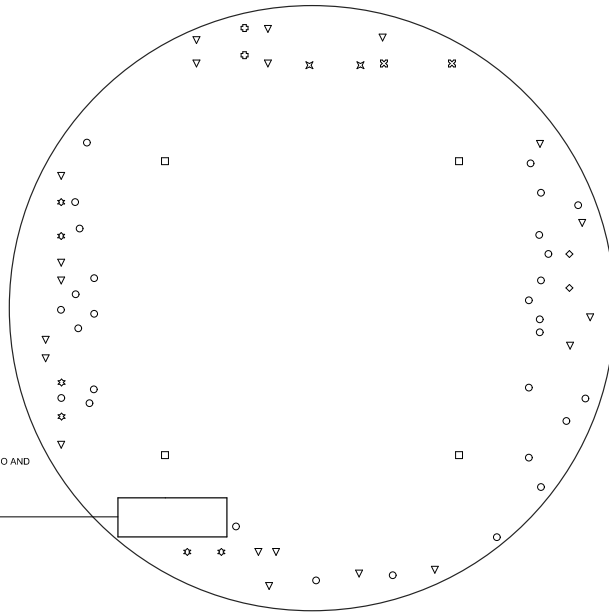


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP6020	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = Bottom Layer			
PLOT NAME = Bottom Layer	GENERATED : 12/16/2014 8:21:47 AM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP6020	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder			
PLOT NAME = Bottom Solder Mask	GENERATED : 12/16/2014 8:21:49 AM	TEXAS INSTRUMENTS	

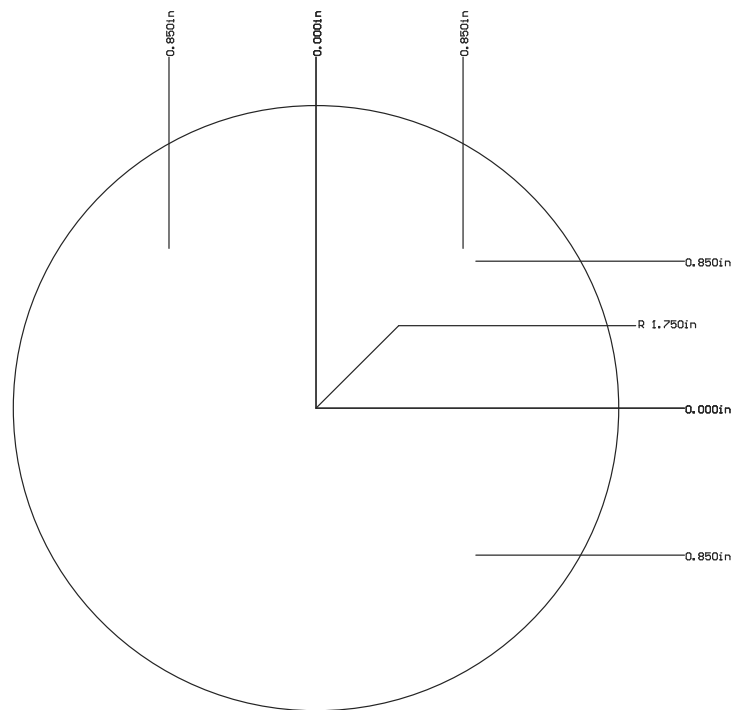
PLACE MFGRS LOGO, UL FLAMMABILITY RATING, Tg TEMP, UL FILE NO AND
DATE CODE HERE ON BOTTOM SIDE



Symbol	Hit Count	Tool Size	Plated	Hole Type
○	29	16mil (0.406mm)	PTH	Round
⌘	2	33.465mil (0.85mm)	PTH	Round
⌘	2	35mil (0.889mm)	PTH	Round
◇	2	35.433mil (0.9mm)	PTH	Round
☆	6	37mil (0.94mm)	PTH	Round
⊙	2	42.079mil (1.069mm)	PTH	Round
▽	20	43mil (1.092mm)	PTH	Round
□	4	128mil (3.251mm)	NPTH	Round
67 Total				

Drill Table

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP6020	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing			
PLOT NAME = Drill Drawing	GENERATED : 12/16/2014 8:21:50 AM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP6020	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions			
PLOT NAME = Board Dimensions	GENERATED : 12/16/2014 8:21:52 AM		TEXAS INSTRUMENTS

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